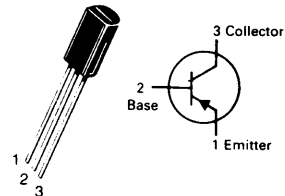


MAXIMUM RATINGS

Rating	Symbol	MPS6728	MPS6729	Unit
Collector-Emitter Voltage	V_{CE0}	60	80	Vdc
Collector-Base Voltage	V_{CBO}	60	80	Vdc
Emitter-Base Voltage	V_{EBO}	5.0		Vdc
Collector Current — Continuous	I_C	500		mAdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	1.0	8.0	Watt mW/°C
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	2.5	20	Watts mW/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-55 to +150		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	50	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	125	°C/W

**MPS6728
MPS6729****CASE 29-03, STYLE 1
TO-92 (TO-226 AE)****AMPLIFIER TRANSISTOR****PNP SILICON**

Refer to MPSW55 for graphs.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage(1) ($I_C = 1.0$ mAdc, $I_E = 0$)	MPS6728 MPS6729	$V_{(BR)CEO}$	60 80	— —	Vdc
Collector-Base Breakdown Voltage ($I_C = 100$ μ Adc, $I_E = 0$)	MPS6728 MPS6729	$V_{(BR)CBO}$	60 80	— —	Vdc
Emitter-Base Breakdown Voltage ($I_E = 10$ μ Adc, $I_C = 0$)		$V_{(BR)EBO}$	5.0	—	Vdc
Collector Cutoff Current ($V_{EB} = 5.0$ Vdc, $I_C = 0$)		I_{EBO}	—	10	μ Adc
Emitter Cutoff Current ($V_{CB} = 40$ Vdc, $I_E = 0$) ($V_{CB} = 60$ Vdc, $I_E = 0$)	MPS6728 MPS6729	I_{CBO}	— —	0.1 0.1	μ Adc

ON CHARACTERISTICS(1)

DC Current Gain ($I_C = 50$ mAdc, $V_{CE} = 1.0$ Vdc) ($I_C = 250$ mAdc, $V_{CE} = 1.0$ Vdc)		h_{FE}	80 50	— 250	— —
Collector-Emitter Saturation Voltage ($I_C = 250$ mAdc, $I_E = 10$ mAdc)		$V_{CE(sat)}$	—	0.5	Vdc
Base-Emitter On Voltage ($I_C = 250$ mAdc, $V_{CE} = 1.0$ Vdc)		$V_{BE(on)}$	—	1.2	Vdc

SMALL-SIGNAL CHARACTERISTICS

Collector-Base Capacitance ($V_{CB} = 10$ Vdc, $I_E = 0$, $f = 1.0$ MHz)		C_{cb}	—	30	pF
Small-Signal Current Gain ($I_C = 200$ mAdc, $V_{CE} = 5.0$ Vdc, $f = 20$ MHz)		h_{fe}	2.5	25	—

(1) Pulse Test: Pulse Width ≤ 300 μ s, Duty Cycle $\leq 2.0\%$.

MAXIMUM RATINGS

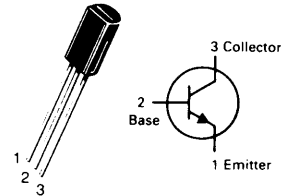
Rating	Symbol	MPS6735	MPS6734	MPS6733	Unit
Collector-Emitter Voltage	V_{CE0}	300	250	200	Vdc
Collector-Base Voltage	V_{CBO}	300	250	200	Vdc
Emitter-Base Voltage	V_{EBO}	6.0			Vdc
Collector Current — Continuous	I_C	300			mAdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	1.0 8.0			Watt mW/ $^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	2.5 20			Watts mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-55 to +150			$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	50	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	125	$^\circ\text{C}/\text{W}$

MPS6733
MPS6734
MPS6735

CASE 29-03, STYLE 1
TO-92 (TO-226 AE)



HIGH VOLTAGE TRANSISTOR

NPN SILICON

Refer to MPSW42 for graphs.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage(1) ($I_C = 10 \text{ mAdc}, I_B = 0$)	$V_{(BR)CEO}$	300 250 200	—	Vdc
Collector-Base Breakdown Voltage ($I_C = 100 \mu\text{Adc}, I_E = 0$)	$V_{(BR)CBO}$	300 250 200	—	Vdc
Emitter-Base Breakdown Voltage ($I_E = 100 \mu\text{Adc}, I_C = 0$)	$V_{(BR)EBO}$	6.0	—	Vdc
Collector Cutoff Current ($V_{CB} = 260 \text{ Vdc}, I_E = 0$) ($V_{CB} = 200 \text{ Vdc}, I_E = 0$) ($V_{CB} = 160 \text{ Vdc}, I_E = 0$)	I_{CBO}	—	0.1 0.1 0.1	μAdc
Emitter Cutoff Current ($V_{EB} = 6.0 \text{ Vdc}, I_C = 0$)	I_{EBO}	—	0.1	μAdc
ON CHARACTERISTICS				
DC Current Gain ($I_C = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$)	h_{FE}	25 40	— 200	—
Collector-Emitter Saturation Voltage ($I_C = 20 \text{ mAdc}, I_B = 2.0 \text{ mAdc}$)	$V_{CE(sat)}$	—	2.0	Vdc
Base-Emitter On Voltage ($I_C = 20 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$)	$V_{BE(on)}$	—	2.0	Vdc
SMALL-SIGNAL CHARACTERISTICS				
Current-Gain — Bandwidth Product ($I_C = 10 \text{ mAdc}, V_{CE} = 20 \text{ Vdc}, f = 20 \text{ MHz}$)	f_T	50	200	MHz
Collector-Base Capacitance ($V_{CB} = 20 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz}$)	C_{cb}	—	3.0	pF

(1) Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

MAXIMUM RATINGS

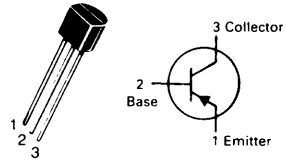
Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	40	Vdc
Collector-Base Voltage	V _{CBO}	40	Vdc
Emitter-Base Voltage	V _{EBO}	5.0	Vdc
Collector Current — Continuous	I _C	200	mA _{dc}
Total Device Dissipation @ T _A = 25°C Derate above 25°C	P _D	625 5.0	mW mW/°C
Total Device Dissipation @ T _C = 60°C	P _D	450	mW
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	1.5 12	Watts mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R _{θJC}	83.3	°C/W
Thermal Resistance, Junction to Ambient	R _{θJA}	200	°C/W

MPS8093

**CASE 29-04, STYLE 1
TO-92 (TO-226AA)**



GENERAL PURPOSE TRANSISTOR

PNP SILICON

Refer to 2N4402 for graphs.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage (I _C = 10 mA _{dc})	V _{(BR)CEO}	40	—	Vdc
Collector-Base Breakdown Voltage (I _C = 100 μA _{dc})	V _{(BR)CBO}	40	—	Vdc
Emitter-Base Breakdown Voltage (I _E = 100 μA _{dc})	V _{(BR)EBO}	5.0	—	Vdc
Collector Cutoff Current (V _{CB} = 20 V)	I _{CBO}	—	100	nA _{dc}
Emitter Cutoff Current (V _{BE} = 3.0 V)	I _{EBO}	—	100	nA _{dc}
ON CHARACTERISTICS				
DC Current Gain (I _C = 50 mA _{dc} , V _{CE} = 2.0 Vdc)	h _{FE}	100	300	—
Collector-Emitter Saturation Voltage (I _C = 50 mA _{dc} , I _B = 5.0 mA _{dc})	V _{CE(sat)}	—	0.25	Vdc
Base-Emitter On Voltage (I _C = 50 mA _{dc} , V _{CE} = 2.0 V)	V _{BE(on)}	0.6	1.0	Vdc